# isola

## 185HR

185HR is a proprietary, high performance resin system with a Tg of 180°C (by DSC) for multilayer Printed Wiring Board (PWB) applications where maximum thermal performance and reliability are required.

185HR laminate and prepreg products are manufactured using Isola's patented technology, reinforced with electrical grade (E-glass) glass fabric. This system delivers a 340°C decomposition temperature, a lower Z-axis expansion and offers lower loss compared to competitive products in this space.

The 185HR system is also laser fluorescing and UV blocking for maximum compatibility with Automated Optical Inspection (AOI) systems, optical positioning systems and photoimageable solder mask imaging.

### **Performance**

Tg 180°C Td 340°C Dk 4.01 Df 0.0200

zIPC- 4101C /21 /24 /26 /98 /101 /126 UL - File Number E41625 Qualified to UL's MCIL Program

#### **Product Features**

· Processing Advantages

#### **Product Availability**

- Available in full size sheet or panel form
- Roll or panel form
- · Glass Fabric Availability

#### ORDERING INFORMATION:

Contact your local sales representative or visit www.isola-group.com for further information.

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## **185HR Specifications**

			Typical Values			
Pro	norty			Units	Test Method	
Property		Typical Value	Specification	Metric (English)	IPC-TM-650 (or as noted)	
Test data generated from		45	-	%	2.3.16.2	
Glass Transition Temperature (Tg) by DSC		180	170-200	°C	2.4.25	
Glass Transition Temperature (Tg) by DMA		185	170-200	°C	2.4.25	
Decomposition Temperature (Td) by TGA @ 5% weight loss		340	-	°C		
		60	-			
		>15	-			
Test data generated from	A. Post-Tg B. Pre-Tg	40 220	AABUS -		2.4.24	
	A. Pre-Tg B.	13/14 14/17	AABUS -		2.4.24	
		2.7	-	%	2.4.24	
Thermal Conductivity		0.4	-	W/mK		
Thermal Stress 10 sec @ 288°C (550.4°F)	A. Unetched B. Etched	Pass	Pass Visual		2.4.13.1	
Test data generated from	A. B. C. D. E. F. G. H.	4.13 4.04 4.01 3.88 3.88 0.0158 0.0192 0.0200 0.0235	5.4 - - - 5.4 - - -	- - - - - - - -	2.5.17.1	
Volume Resistivity	J. A.	0.0236	1.0x106	MM-cm	2.5.17.1	
	B. After moisture resistance C. At elevated temperature	3.0x108 7.0x108	- 1.0x103	M⊠-cm		
Surface Resistivity	A. B. After moisture resistance C. At elevated temperature	- 3.0x106 2.0x108	1.0x106 — 1.0x103	MI	2.5.17.1	
Dielectric Breakdown		>50	-	kV	2.5.6	
Arc Resistance		115	60	Seconds	2.5.1	
		54 (1350)	30 (750)			
Comparative Tracking Index (CTI)		3 (175-249)	_	Class (Volts)		
Peel Strength	A. B. Standard profile copper 1. After thermal stress 2. After thermal stress 3. At 125°C (257°F) 4. After process solutions	0.969 (5.5) - 1.06 (5.9) 1.06 (5.9) 0.969 (5.5)	0.70 (4.0) - 0.80 (4.5) 0.70 (4.0) 0.55 (3.5)		2.4.8.3 2.4.4	
Flexural Strength	A. B.	97,100 54,100	-	lb/inch2	2.4.4	
Tensile Strength	A. B.	53,337 35,678	-	lb/inch2		
Test data generated from	A. B.	3770 3337	-	-		
Poisson's Ratio	A. B.	0.172 0.155	-	-		
Moisture Absorption		0.15	-	%	2.6.2.1	
Test data generated from		V-0	_	°C		
Max Operating Temperature		130	UL Cert	°C		

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.

#### isola. keo staging. com/products/printed-circuit-materials/185 hr-laminate-materials/

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